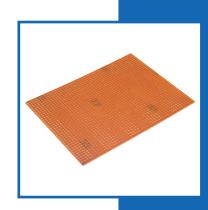


Copper Track Stripboard



DESCRIPTION

These stripboards provide a simple form of printed circuit. The boards have strips (tracks) and holes on a 2.54mm (0.1in) pitch and are manufactured from copper-clad paper and phenolic laminate body material, protected with OSP.

DISTINCTIVE FEATURES

- Available in a choice of sizes
- Paper & phenolic laminate body
- 1Oz (34µm) Copper contact material
- · Can be readily cut to size

- Board Thickness 1.5mm
- Grid Pitch 2.5mm (0.1in)
- Surface treated with OSP (Organic Solderability Preservative)

APPLICATIONS

Ideal for prototype and development work, great for soldering training & practice, component forming training, and introduction to practical electronics. Suitable for use in industrial applications, for hobbyist use and for use in education.













GENERAL SPECIFICATION

Number of Tracks	See Part Number Table - page 3	
Number of holes	See Part Number Table - page 3	
Weight	See Part Number Table - page 3	

Test item	st item		Condition	Standard Value	Guaranteed Value
Volume Resistivity			C-96/20/65	1 x 10 ¹² - 5 x 10 ¹³	Above 1 x 10 ¹²
		Ω/cm	C-96/20/65+C-96/40/90	1 x 10 ¹² - 1 x 10 ¹³	Above 1 x 10 ¹¹
	Adhesive Surface	Ω	C-96/20/65	5 x 10 ¹¹ - 1 x 10 ¹²	Above 1 x 10 ¹⁰
Surface Resistance			C-96/20/65+C-96/40/90	1 x 10 ¹⁰ - 1 x 10 ¹¹	Above 1 x 10 ⁹
	Laminate Surface	Ω	C-96/20/65	5 x 10 ⁹ - 1 x 10 ¹¹	Above 1 x 10 ⁹
			C-96/20/65+C-96/40/90	5 x 10 ⁸ - 1 x 10 ⁹	Above 1 x 10 ⁸
Insulation Resistance			C-96/20/65	5 x 10 ¹¹ - 1 x 10 ¹²	Above 1 x 10 ¹⁰
		Ω	C-96/20/65+D-2/100	5 x 10 ⁷ - 5 x 10 ⁸	Above 1 x 10 ⁷
(1MHz) Dielectric Constant			C-96/20/65	4.3 - 5.0	Less than 5.5
		_	C-96/20/65+D-48/50	5.3 - 5.8	Less than 6.0
(1MHz) Dissipation Factor			C-96/20/65	0.035 - 0.046	Less than 0.05
		-	C-96/20/65+D-48/50	0.050 - 0.060	Less than 0.08
(260°C) Solder Heat Resistance		sec	А	20 - 35	Above 10
	(35µm)	kgf/cm	А	1.9 - 2.3	Above 1.5
Peel Strength	Copper Foil		S	1.9 - 2.3	Above 1.5
Flexural Strength (crosswise direction)		kgf/mm2	А	12 - 16	Above 10
Water Absorption		%	E-24/50+D-24/23	0.8 - 1.4	Less than 1.8
Heat Resistance		_	А	205°C to 210°C 30 min no blistering	190°C 30 min no blistering
Flame Resistance (UL94 method)		sec	UL sub 94	_	-
Alkali Resistance		_	Immersion in 3% NaOH	No abnormality	No abnormality
Punching Temperature		_	A Suitable tempera 50°C to 70°C		-



MATERIALS

Material	Paper & phenolic laminate body		
Track Material	1 Oz Copper (34µm thickness)		
Copper Surface Treatement	OSP (Organic Solderability Preservative)		



DIMENSIONS/DRAWINGS

Units	mm - unless stated otherwise		
Hole Pitch	2.54mm (0.1in)		
Hole Diameter	1mm		
Thickness	1.5mm		





PART NUMBER TABLE

Part Number	Dimensions		Topolog	11-1	Weight	EAN	LINODOO	Country of
	Width	Length	Tracks	Holes	(g)	EAN	UNSPSC	Origin
34-0410	25	64	9	25	4	5053556001415	81101702	China
34-0411	64	95	24	37	11	5053556001422	81101702	China
34-0412	95	127	36	50	22	5053556001439	81101702	China
34-0413	95	432	36	170	77	5053556001446	81101702	China
34-0414	119	455	46	179	100	5053556001453	81101702	China



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